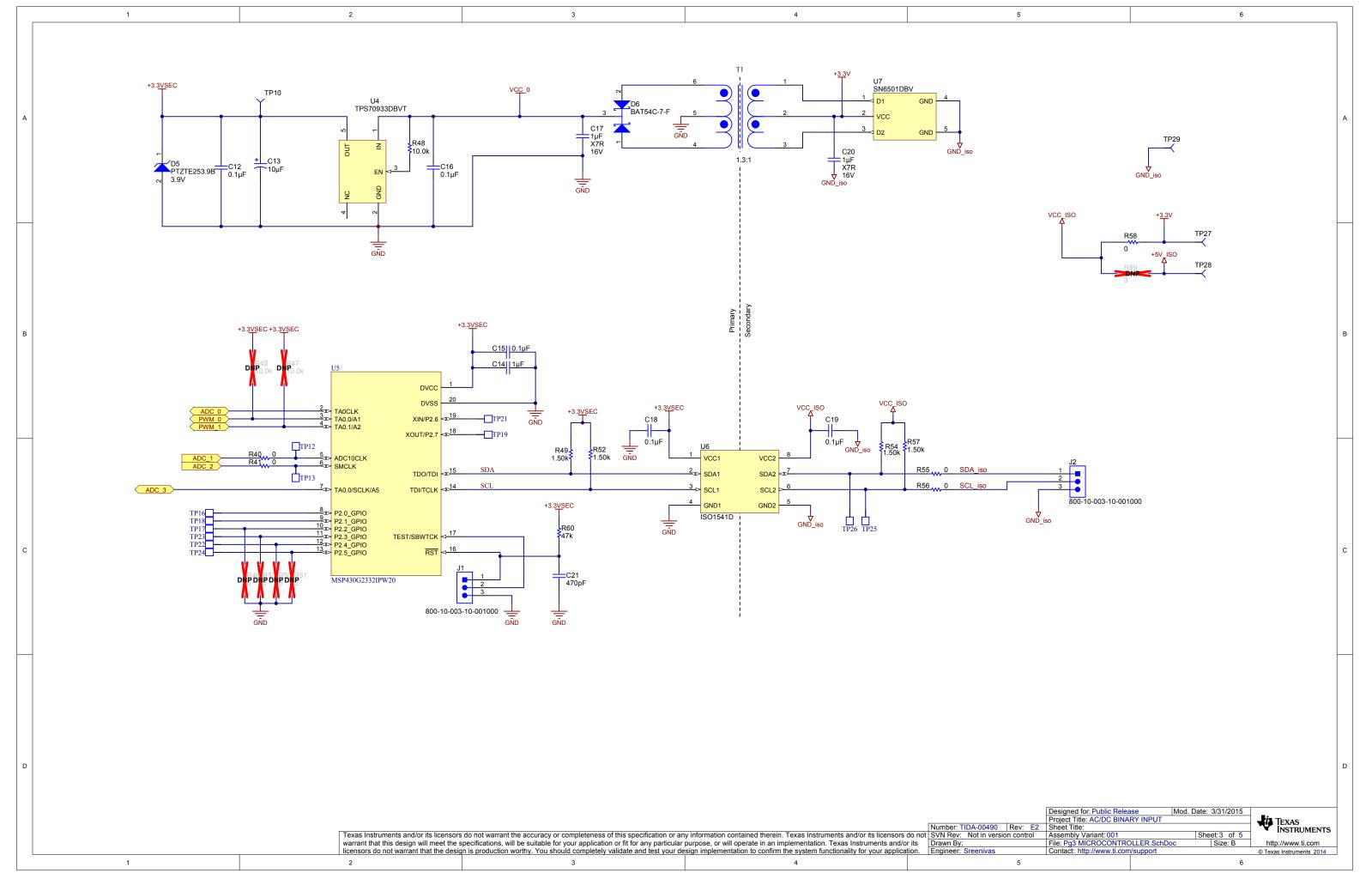
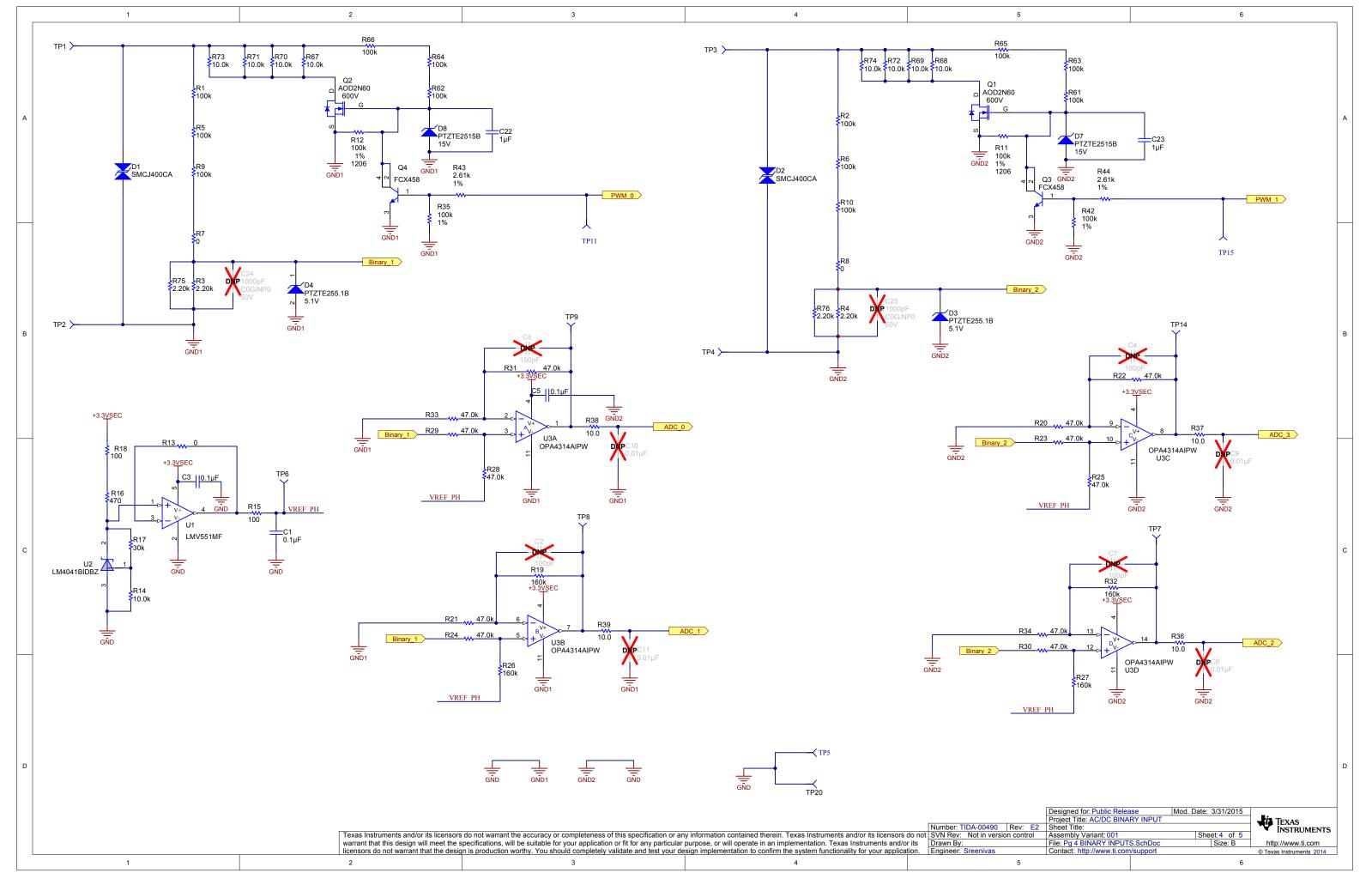


AC/DC binary input +3.3V 3.3V LDO TP23 Transformer TPS70933DBVT 15V-276V Driver Transistor Φ SN6501 DGND bias from 3.3V_Sec Isolated DC input -GND 15V BI1 Isolated 15V-276V GND TP25 Wetting Control BI1 AC/DC MOSFET plus 10K Transistor switch current Limit 3.3V_Sec +3.3V 3.3V_Sec To Host MCU BI1 ADC_L Resistor Divider Plus protection ISO1541D 15V-276V Binary Input 1 ADC_H AC/DC MSP430G2332IPW20 ISO7220ADR **DGND** Resistor Divider BI2 Plus protection Isolated Binary Input 2 15V-276V GND AC/DC BI2 Wetting 15V-276V Control BI2 Y AC/DC MOSFET plus 10K Transistor current Limit 12C Address switch resistor configuration + Programming Transisto bias from DC input -15V BI2 15V-276V LM4041BIDBZ AC/DC Mod. Date: 3/9/2015 TEXAS INSTRUMENTS Texas Instruments and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. Texas Instruments and/or its licensors do not SVN Rev: Not in version control Assembly Variant: 001
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